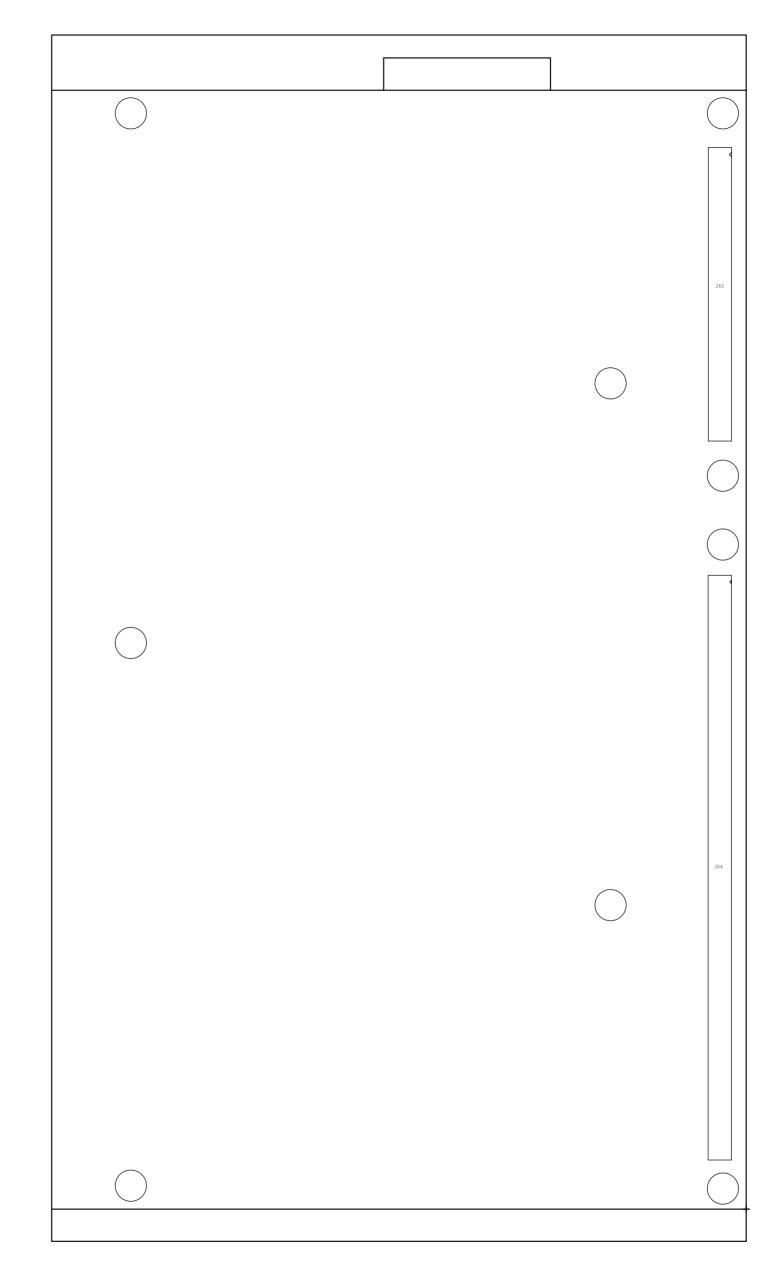


ASSEMBLY TOP K2G AUDIO DC REV B



ASSEMBLY BOTTOM K2G AUDIO DC REV B

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